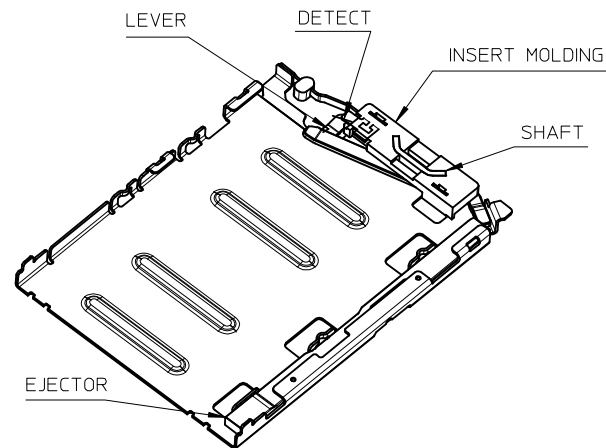
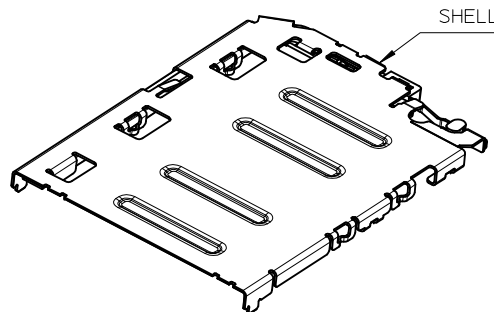
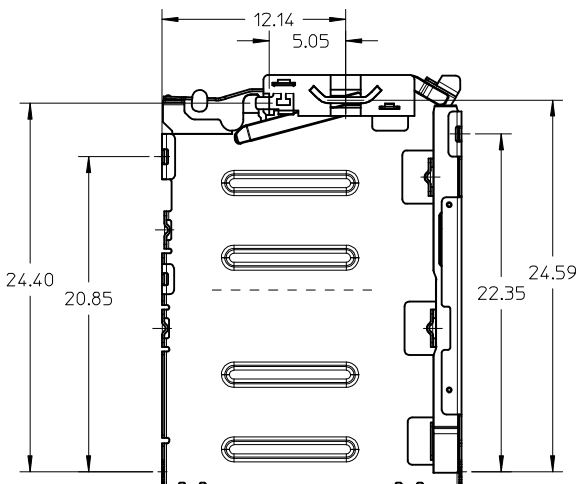
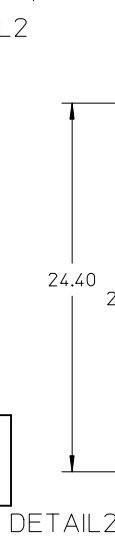
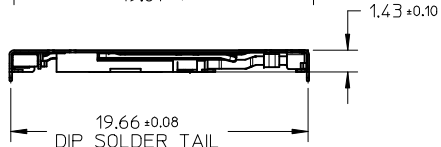
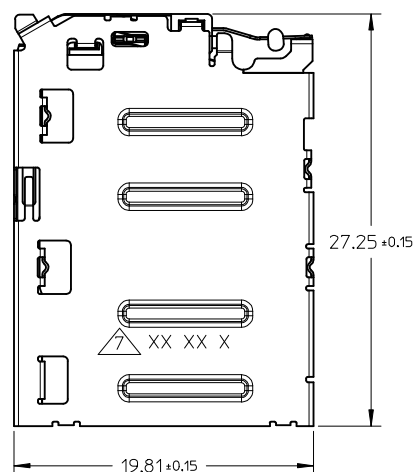
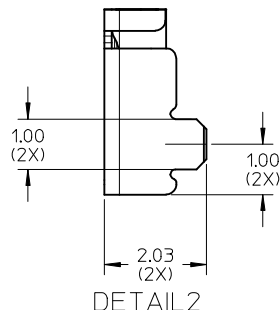


THIS DESIGN IS BASED ON DESIGN OBJECTIVES AND IS STRICTLY TENTATIVE. IT MAY CHANGE BASED ON RESULTS OF ADDITIONAL DESIGN REVIEWS & VERIFICATIONS.



- NOTES:
1. MATERIALS:
INSERT MOLD HOUSING: LCP, UL94V-0;
LEVER, SHAFT, EJECTOR, SHELL: STAINLESS STEEL;
DETECT SPRING: COPPER ALLOY;
 2. FINISHES:
DETECT SPRING:
1.27um MIN. NICKEL UNDERPLATING OVERALL;
0.127um MIN. GOLD PLATING ON CONTACT AREA;
1.27 um MIN. TIN PLATING ON SOLDERING TAIL;
SHELL:
1.27um MIN NICKEL UNDERPLATING OVERALL;
0.025um MIN GOLD PLATING ON CONTACT AREA AND SOLDERING AREA;
SHAFT: 1.27um MIN TIN ON SOLDERING TAIL;
 3. PRODUCT SPECIFICATION: PS-151031-2001;
 4. PACKAGING SPECIFICATION: PK-151031-0001;
 5. SOLDER TAIL COPLANARITY: 0.10 MM MAX BEFORE REFLOW
 6. THIS PART IS A FRAME ONLY, IT SHOULD BE USED TOGETHER WITH 0.38MM BLOCK SIM 151130 FOR AN ENTIRE SIM POP OUT SYSTEM;
 7. DATE CODE PRINTED: XX XX X
DAY
WEEK
YEAR

UPDATED DRAWING FOR TYPE EC NO: S2015-1182 DRWN: JZENG CHKD: JTAN02 APPR: KHLIM	REV 12	DESCRIPTION 2015/06/29 2015/07/07 2015/07/12	QUALITY SYMBOLS F _A =0 F _G =0 F _P =0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE NTS	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION				
						DRAWN BY JZENG	DATE 2014/07/01	TITLE DUAL SIM FRAME CONNECTOR 1.43H						
						CHECKED BY JTAN02	DATE 2014/07/01							
						APPROVED BY		DATE	molex					
				ANGULAR ± 3 °		MATERIAL NO. 1510312001		DOCUMENT NO. SD-151031-0001					SHEET NO. 1 OF 5	
				DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								

10 9 8 7 6 5 4 3 2 1

F

E

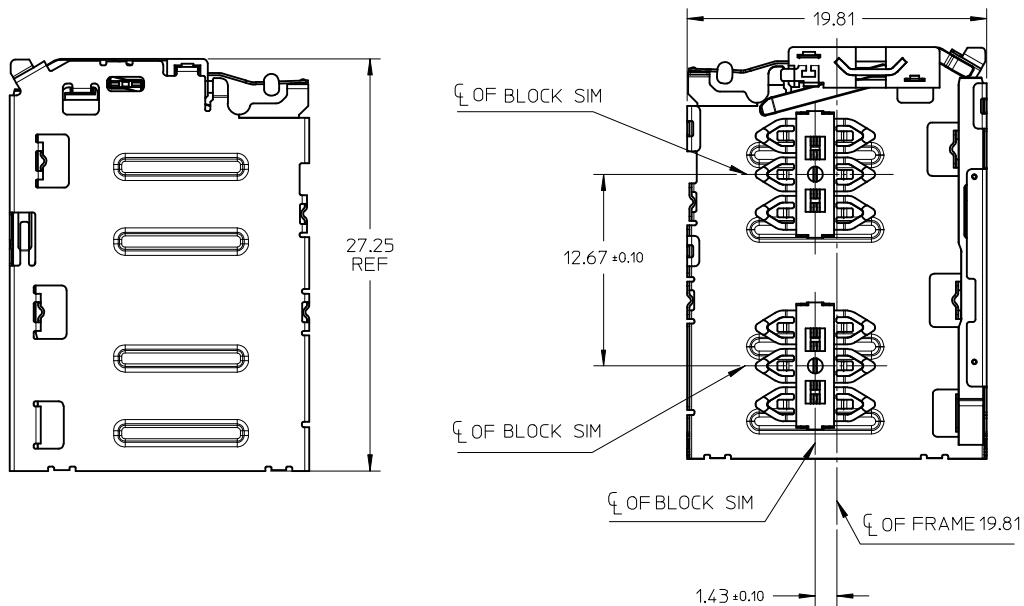
D

C

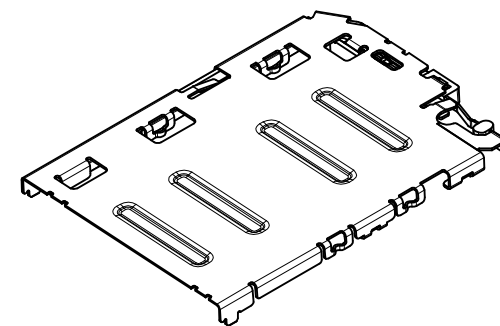
B

A

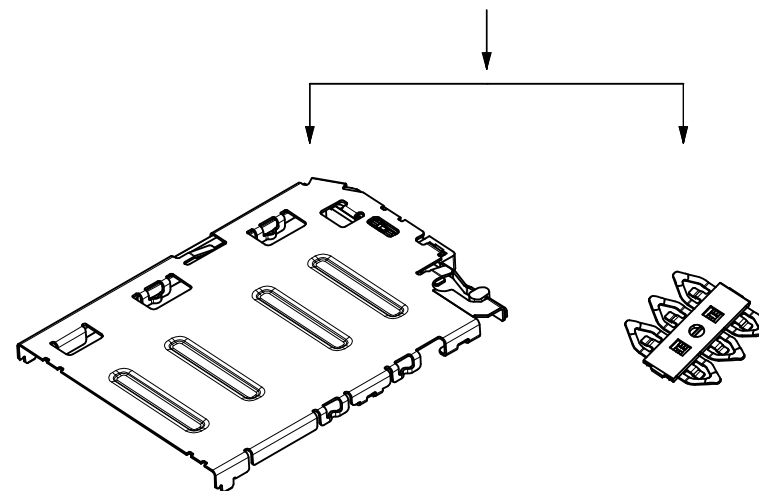
SIM CONNECTOR
(WITH 151130 BLOCK SIM CONNECTOR)



SIM CONNECTOR BOM



FRAME + BLOCK SIM



151031 SERIES

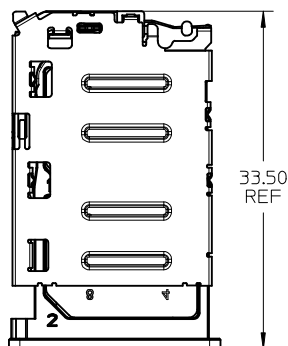
151130 SERIES

THIS DESIGN IS BASED ON DESIGN OBJECTIVES
AND IS STRICTLY TENTATIVE. IT MAY CHANGE
BASED ON RESULTS OF ADDITIONAL DESIGN
REVIEWS & VERIFICATIONS.

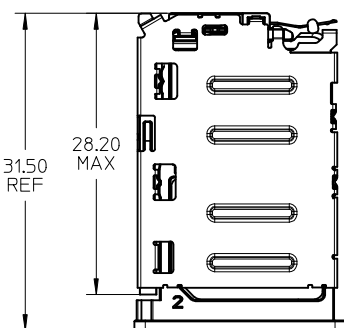
SEE SHEET1 EC NO: S2015-1182 DRWN: JZENG CHKD: JTAN02 APPR: KHLIM	2015/06/29 2015/07/07 2015/07/22	DESCRIPTION REV	QUALITY SYMBOLS F_A=0 F_G=0 F_P=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE NTS	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
					mm	INCH	DRAWN BY JZENG	DATE 2014/07/01	TITLE DUAL SIM FRAME CONNECTOR 1.43H			
				4 PLACES	± ---	± ---	CHECKED BY JTAN02	DATE 2014/07/01				
				3 PLACES	± ---	± ---	APPROVED BY DATE		molex			
				2 PLACES	± 0.20	± ---						
				1 PLACE	± 0.20	± ---						
0 PLACE	± ---	± ---	MATERIAL NO. 1510312001		DOCUMENT NO. SD-151031-0001		SHEET NO. 2 OF 5					
12			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						

10 9 8 7 6 5 4 3 2 1

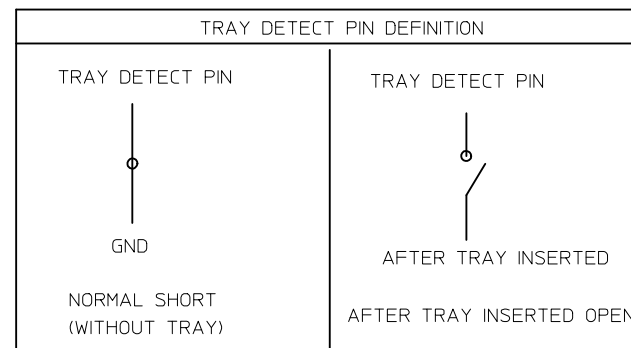
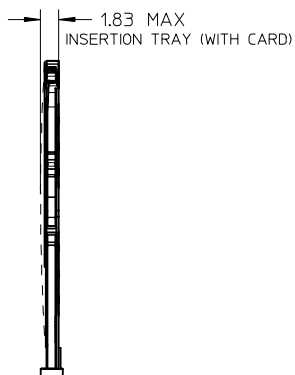
SIM CONNECTOR FRAME AND TRAY



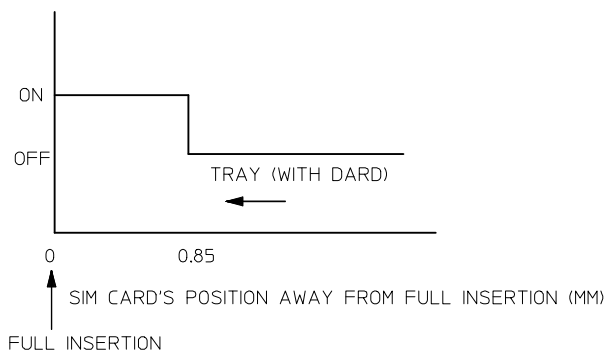
TRAY EJECTED POSITION



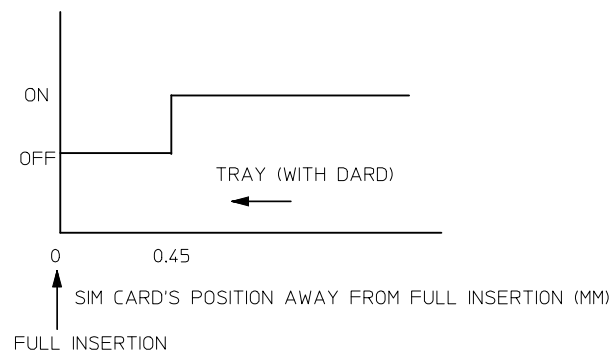
TRAY INSERTION POSITION



SIGNAL PIN

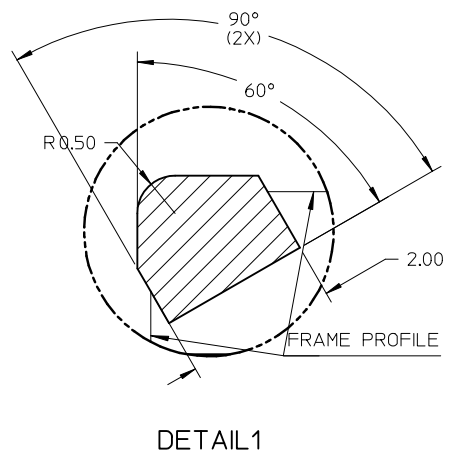


DETECT SWITCH PIN



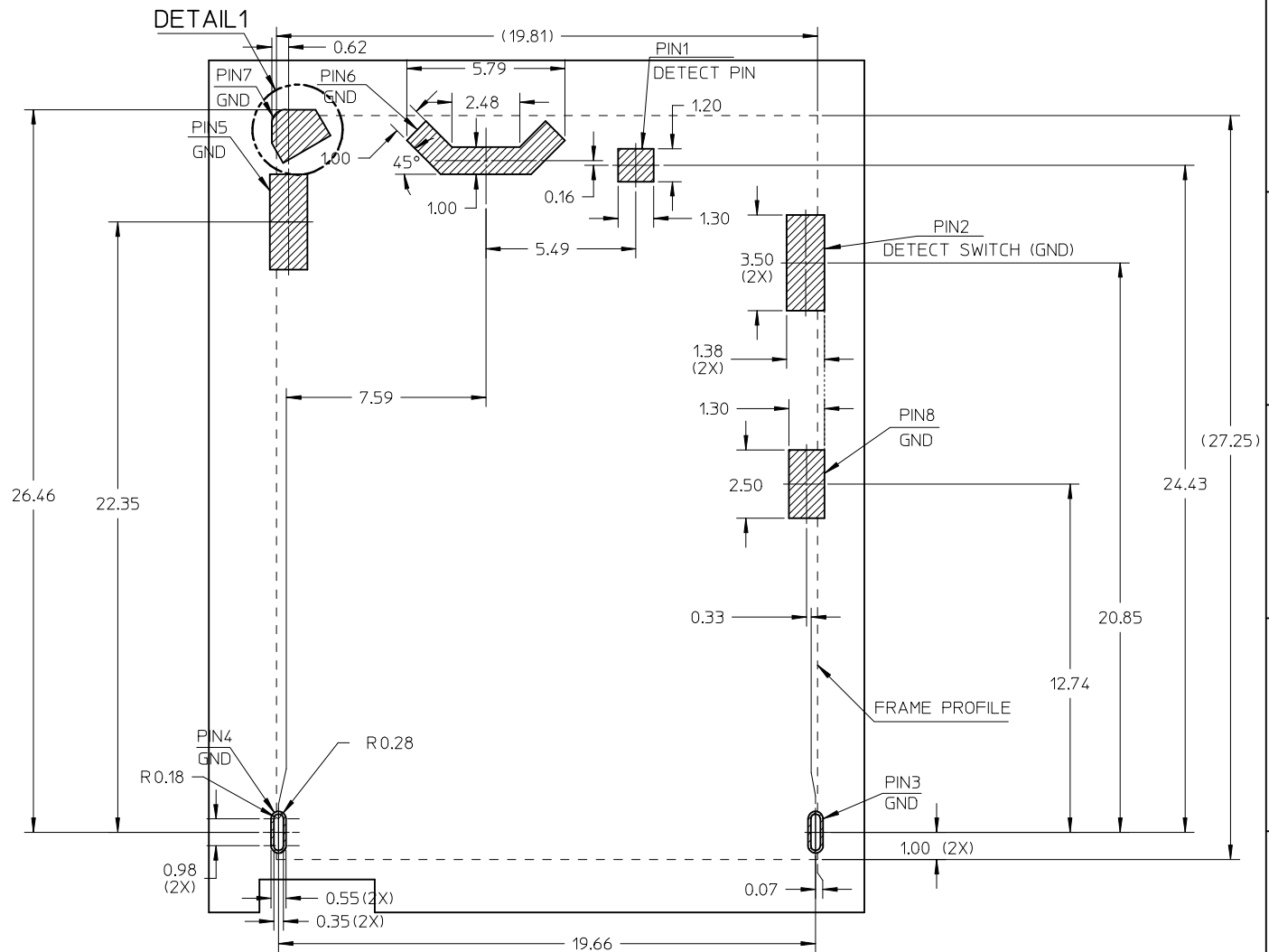
SEE SHEET 1 EC NO: S2015-1182 DRWN: JZENG CHKD: JTAN02 APPR: KHLIM 12	DESCRIPTION REV	QUALITY SYMBOLS =0 =0 =0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION							
				mm	INCH	DRAWN BY JZENG	DATE 2014/07/01	TITLE DUAL SIM FRAME CONNECTOR 1.43H								
						CHECKED BY JTAN02	DATE 2014/07/01									
						APPROVED BY							DATE			
						1 PLACE		± 0.20		± ---		molex				
						0 PLACE		± ---		± ---						
						ANGULAR ± 3 °		MATERIAL NO. 1510312001		DOCUMENT NO. SD-151031-0001		SHEET NO. 3 OF 5				
						DRAFT WHERE APPLICABLE		SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						
						MUST REMAIN WITHIN DIMENSIONS										

F 151031 FRAME SOLDERING AREA: 



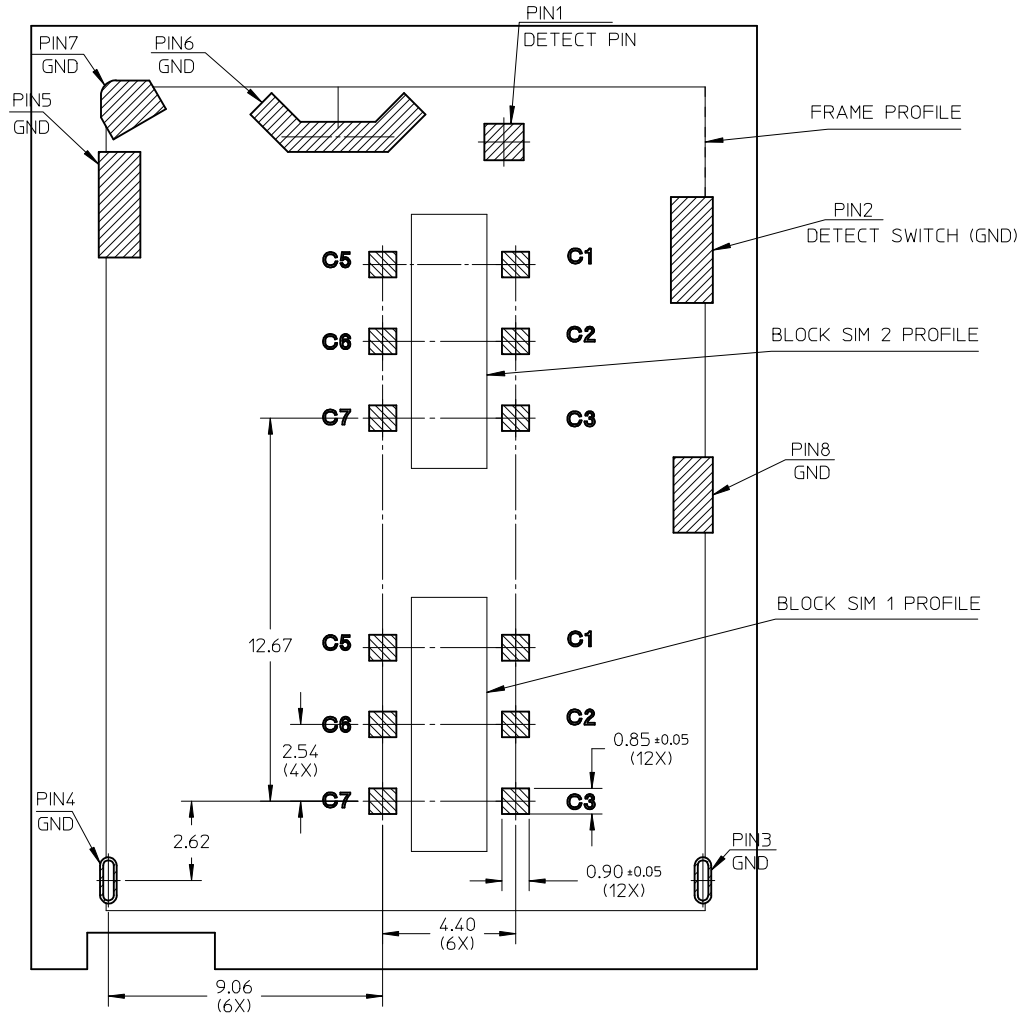
THIS DESIGN IS BASED ON DESIGN OBJECTIVES AND IS STRICTLY TENTATIVE. IT MAY CHANGE BASED ON RESULTS OF ADDITIONAL DESIGN REVIEWS & VERIFICATIONS.

RECOMMENDED PCB LAYOUT: TOLERANCE ±0.05
RECOMMENDED PCB THICKNESS: 1.00MM
RECOMMENDED STENCIL THICKNESS: 0.10MM



SEE SHEET 1 EC NO: S2015-1182 DRWN: JZENG CHKD: JTAN02 APPR: KHLIM	DESCRIPTION REV	QUALITY SYMBOLS F_A=0 F_G=0 F_P=0	GENERAL TOLERANCES (UNLESS SPECIFIED)			DIMENSION STYLE MM ONLY		SCALE NTS	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION				
				mm	INCH	DRAWN BY JZENG	DATE 2014/07/01	TITLE DUAL SIM FRAME CONNECTOR 1.43H						
			4 PLACES	± ---	± ---	CHECKED BY JTAN02	DATE 2014/07/01	molex						
			3 PLACES	± ---	± ---	APPROVED BY DATE								
			2 PLACES	± 0.20	± ---	DOCUMENT NO. SD-151031-0001								
			1 PLACE	± 0.20	± ---						MATERIAL NO. 1510312001		SHEET NO. 4 OF 5	
			0 PLACE	± ---	± ---									
			ANGULAR ± 3 °											
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS											

F
151031 FRAME SOLDERING AREA: 
151130 BLOCK SIM SOLDERING AREA: 



THIS DESIGN IS BASED ON DESIGN OBJECTIVES AND IS STRICTLY TENTATIVE. IT MAY CHANGE BASED ON RESULTS OF ADDITIONAL DESIGN REVIEWS & VERIFICATIONS.

RECOMMENDED PCB LAYOUT: TOLERANCE ±0.05
RECOMMENDED PCB THICKNESS: 1.0MM
RECOMMENDED STENCIL THICKNESS: 0.10MM

SEE SHEET 1 EC NO: S2015-1182 DRWN: JZENG CHKD: JTAN02 APPR: KHLIM	2015/06/29 2015/07/07 2015/07/22	DESCRIPTION	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)			DIMENSION STYLE MM ONLY		SCALE NTS	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
					mm	INCH	DRAWN BY	DATE	TITLE				
				4 PLACES	± ---	± ---	JZENG	2014/07/01	DUAL SIM FRAME CONNECTOR				
				3 PLACES	± ---	± ---	CHECKED BY	DATE	1.43H				
				2 PLACES	± 0.20	± ---	JTAN02	2014/07/01	molex				
				1 PLACE	± 0.20	± ---	APPROVED BY	DATE					
				0 PLACE	± ---	± ---							
				ANGULAR ± 3 °			MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
				DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			1510312001		SD-151031-0001		5 OF 5		
							SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					
REV													

molex



**Стандарт
Электрон
Связь**

Мы молодая и активно развивающаяся компания в области поставок электронных компонентов. Мы поставляем электронные компоненты отечественного и импортного производства напрямую от производителей и с крупнейших складов мира.

Благодаря сотрудничеству с мировыми поставщиками мы осуществляем комплексные и плановые поставки широчайшего спектра электронных компонентов.

Собственная эффективная логистика и склад в обеспечивает надежную поставку продукции в точно указанные сроки по всей России.

Мы осуществляем техническую поддержку нашим клиентам и предпродажную проверку качества продукции. На все поставляемые продукты мы предоставляем гарантию .

Осуществляем поставки продукции под контролем ВП МО РФ на предприятия военно-промышленного комплекса России , а также работаем в рамках 275 ФЗ с открытием отдельных счетов в уполномоченном банке. Система менеджмента качества компании соответствует требованиям ГОСТ ISO 9001.

Минимальные сроки поставки, гибкие цены, неограниченный ассортимент и индивидуальный подход к клиентам являются основой для выстраивания долгосрочного и эффективного сотрудничества с предприятиями радиоэлектронной промышленности, предприятиями ВПК и научно-исследовательскими институтами России.

С нами вы становитесь еще успешнее!

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Электронная почта: sales@st-electron.ru

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Промышленная ул, дом № 19, литера Н,
помещение 100-Н Офис 331